

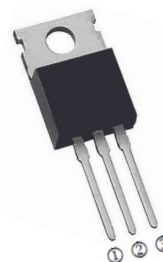
RoHS Compliant Product  
A suffix of "-C" specifies halogen free

## DESCRIPTION

The SSE184N10SV-C is the Shielded Gate Technology N-ch MOSFETs with extreme high cell density, which provide excellent  $R_{DS(ON)}$  and gate charge for most of the synchronous buck converter applications.

The SSE184N10SV-C meet the RoHS and Green Product requirement with full function reliability approved.

TO-220



## FEATURES

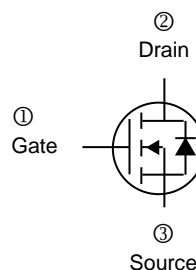
- Shielded Gate Trench Technology
- Super Low Gate Charge
- Green Device Available

## MARKING



## ORDER INFORMATION

Part Number	Type
SSE184N10SV-C	Lead (Pb)-free and Halogen-free



## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub>=25°C unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current <sup>1</sup> (Silicon Limited)	I <sub>D</sub>	T <sub>C</sub> =25°C	184
		T <sub>C</sub> =100°C	130
Continuous Drain Current <sup>1</sup> (Package Limited)	I <sub>D</sub>	T <sub>C</sub> =25°C	120
Pulsed Drain Current <sup>2</sup>	I <sub>DM</sub>	520	A
Power Dissipation	P <sub>D</sub>	T <sub>C</sub> =25°C	283
Operating Junction & Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55~175	°C
<b>Thermal Resistance Rating</b>			
Thermal Resistance Junction-Ambient <sup>1</sup>	R <sub>θJA</sub>	60	°C/W
Thermal Resistance Junction-Case <sup>1</sup>	R <sub>θJC</sub>	0.53	

**ELECTRICAL CHARACTERISTICS** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions	
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	100	-	-	V	$V_{GS}=0V, I_D=250\mu A$	
Gate-Threshold Voltage	$V_{GS(th)}$	2	-	4	V	$V_{DS}=V_{GS}, I_D=250\mu A$	
Forward Transfer Conductance	$g_{fs}$	-	70	-	S	$V_{DS}=5V, I_D=20A$	
Gate-Source Leakage Current	$I_{GSS}$	-	-	$\pm 100$	nA	$V_{GS}=\pm 20V$	
Drain-Source Leakage Current	$I_{DSS}$	$T_J=25^\circ\text{C}$	-	-	1	$\mu A$	$V_{DS}=100V, V_{GS}=0V$
		$T_J=100^\circ\text{C}$	-	-	100		
Static Drain-Source On-Resistance <sup>3</sup>	$R_{DS(ON)}$	-	3.4	4	m $\Omega$	$V_{GS}=10V, I_D=20A$	
Gate Resistance	$R_g$	-	0.6	-	$\Omega$	$f=1\text{MHz}$	
Total Gate Charge	$Q_g$	-	87	-	nC	$I_D=20A$ $V_{DD}=50V$ $V_{GS}=10V$	
Gate-Source Charge	$Q_{gs}$	-	22	-			
Gate-Drain Change	$Q_{gd}$	-	21	-			
Turn-on Delay Time	$T_{d(on)}$	-	24	-	nS	$V_{DD}=50V$ $I_D=20A$ $V_{GS}=10V$ $R_G=10\Omega$	
Rise Time	$T_r$	-	18	-			
Turn-off Delay Time	$T_{d(off)}$	-	36	-			
Fall Time	$T_f$	-	9	-			
Input Capacitance	$C_{iss}$	-	5995	-	pF	$V_{GS}=0V$ $V_{DS}=50V$ $f=1\text{MHz}$	
Output Capacitance	$C_{oss}$	-	923	-			
Reverse Transfer Capacitance	$C_{rss}$	-	13.8	-			
<b>Source-Drain Diode</b>							
Diode Forward Voltage <sup>3</sup>	$V_{SD}$	-	0.9	1.2	V	$I_F=20A, V_{GS}=0V$	
Reverse Recovery Time	$T_{rr}$	-	71	-	nS	$I_F=20A, V_R=50V$ $di_F/dt=100A/\mu s$	
Reverse Recovery Charge	$Q_{rr}$	-	114	-	nC		

Notes:

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2oz copper.
2. The Pulse width limited by maximum junction temperature, Pulse Width $\leq 300\mu s$ , Duty Cycle $\leq 2\%$ .
3. The Pulse Test: Pulse Width $\leq 300\mu s$ , Duty Cycle $\leq 2\%$ .

**CHARACTERISTIC CURVES**

Fig 1. Typical Output Characteristics

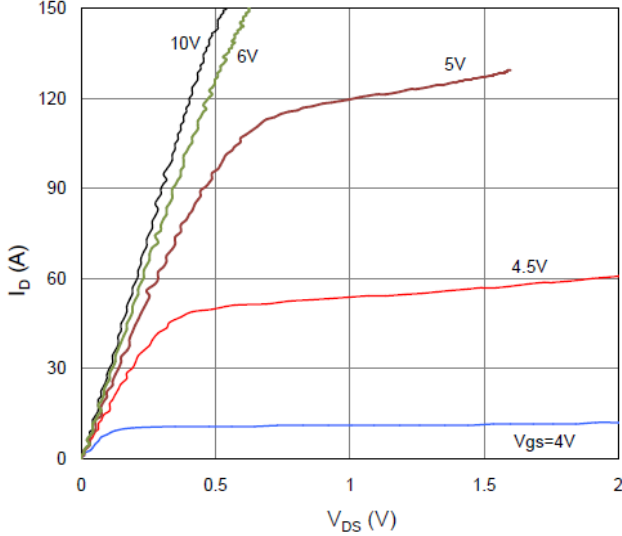


Figure 2. On-Resistance vs. Gate-Source Voltage

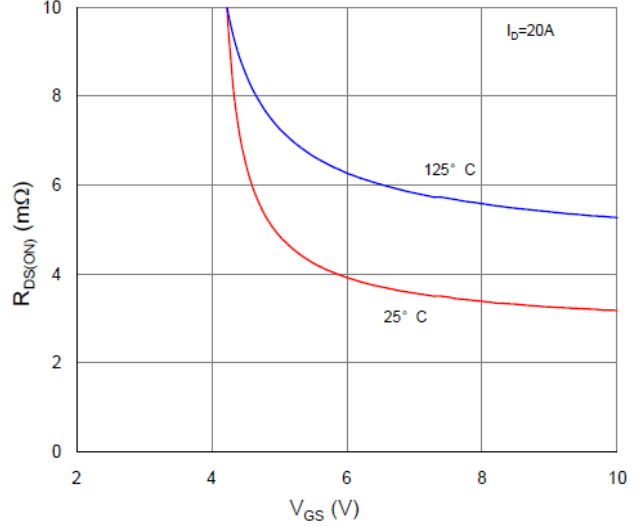


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

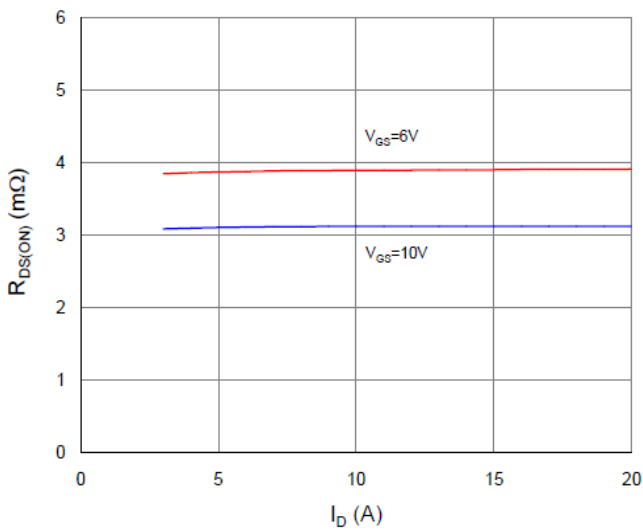


Figure 4. Normalized On-Resistance vs. Junction Temperature

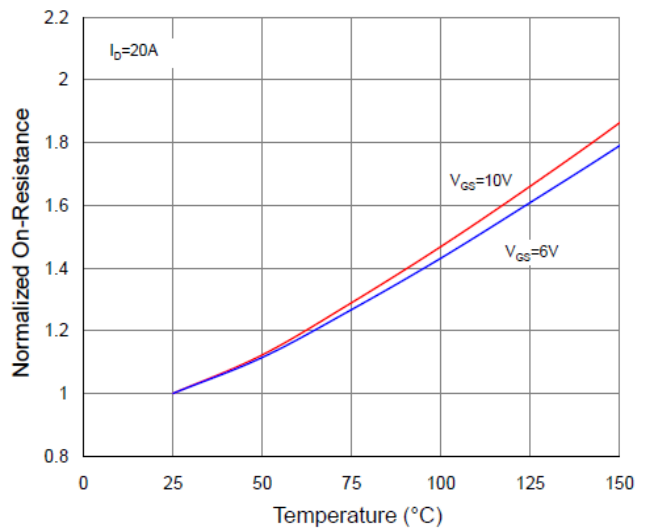


Figure 5. Typical Transfer Characteristics

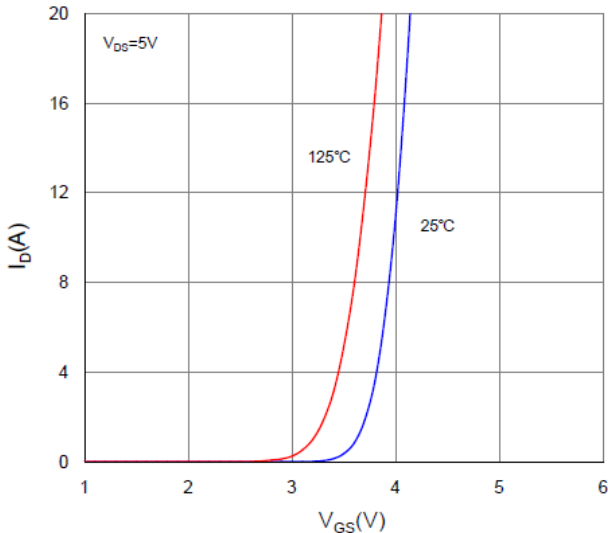
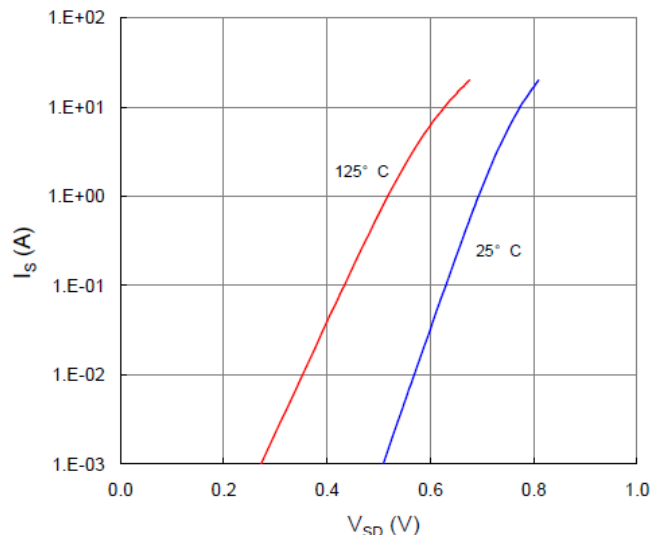


Figure 6. Typical Source-Drain Diode Forward Voltage



**CHARACTERISTIC CURVES**

Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

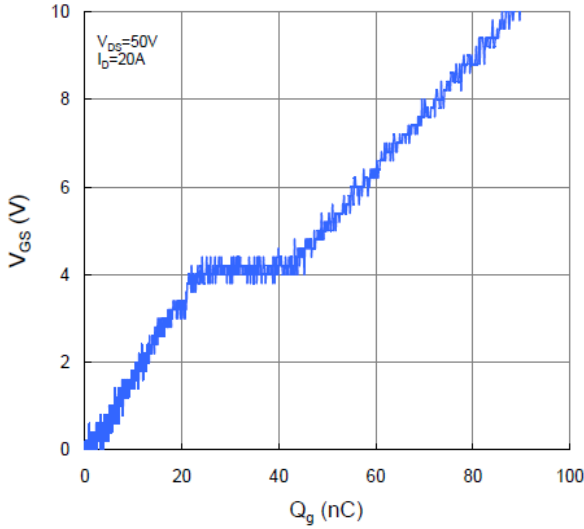


Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

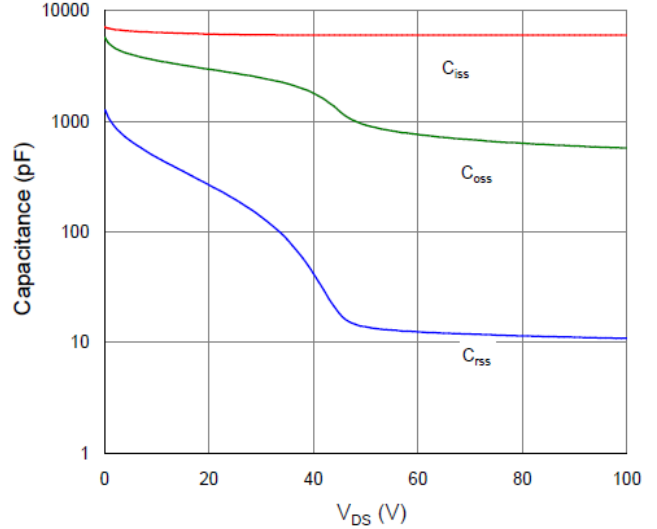


Figure 9. Maximum Safe Operating Area

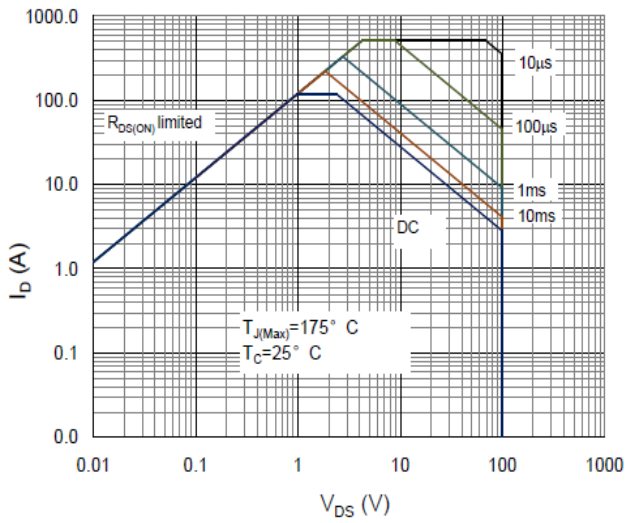


Figure 10. Maximum Drain Current vs. Case Temperature

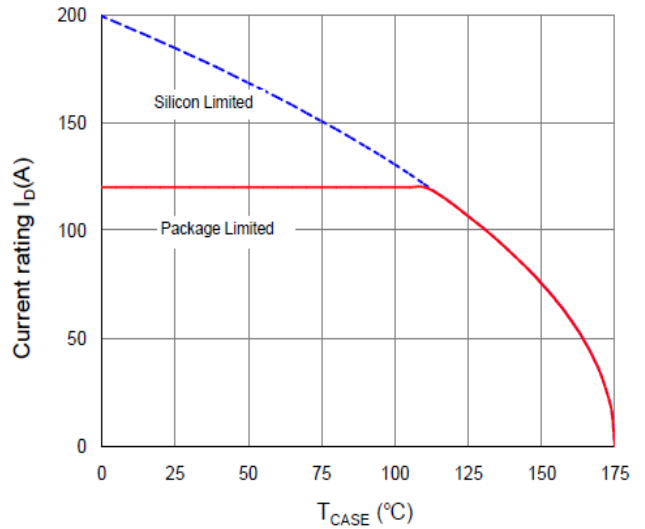
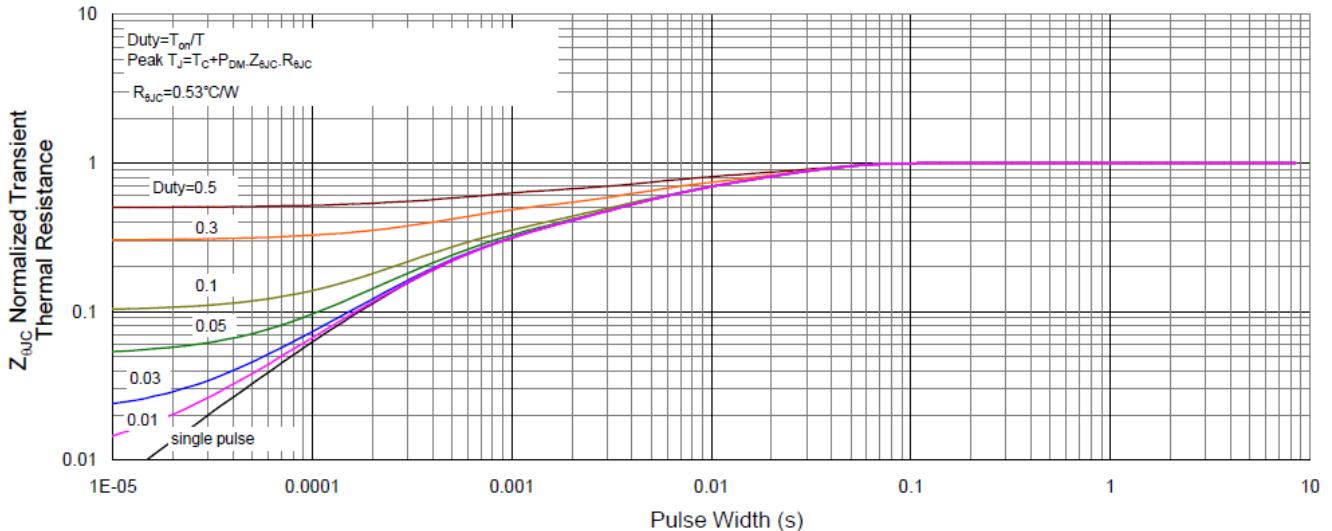
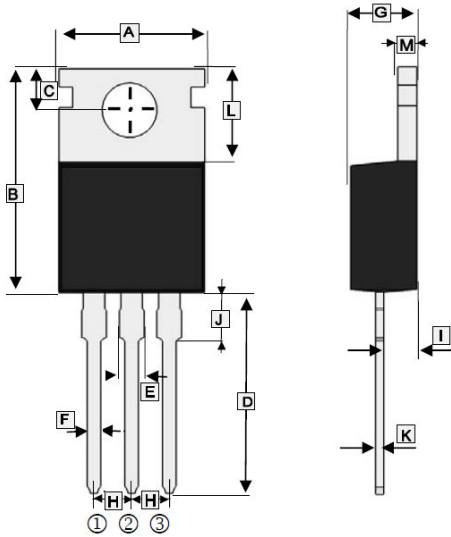


Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Case



**PACKAGE OUTLINE DIMENSIONS**

TO-220



REF.	Millimeter	
	Min.	Max.
A	9.70	10.60
B	14.22	16.50
C	2.54	3.40
D	12.70	14.70
E	1.17	1.78
F	0.40	1.00
G	3.60	4.82
H	2.54 TYP.	
I	2.03	2.92
J	2.70	4.00
K	0.33	0.65
L	5.50	7.00
M	1.15	1.40